

100V P-Channel Trench MOSFET

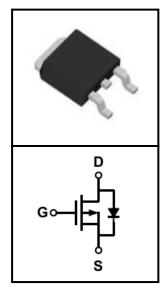
FEATURES

- Super Low Gate Charge
- 100% EAS Guaranteed
- RoHS compliant
- Green Device Available
- Excellent CdV/dt effect decline
- Advanced high cell density Trench technology

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Hard switched and high frequency circuits





Device Marking and Package Information				
Device	Package	Marking		
CTD10P650	TO-252	CTD10P650		

Parameter		Symbol	Value	Unit
Drain-Source Voltage (V _{GS} = 0V)		V_{DSS}	-100	V
Continuous Drain Current T _C = 25°C	(note1)		-5.3	
Continuous Drain Current T _C = 100°C	(note1)	l _D	-3.2	A
Pulsed Drain Current	(note2)	I _{DM}	-8.5	А
Gate Source Voltage		V_{GSS}	±20	V
Power Dissipation $T_C = 25^{\circ}C$	(note4)	P_D	1	W
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55~+175	°C

Thermal Characteristics					
Parameter		Symbol	Value	Unit	
Thermal Resistance, Junction-to-Ambient	(note1)	$R_{\theta JA}$	62	°C/W	
Thermal Resistance, Junction-case	(note1)	R _{eJC}	6	°C/W	



Electrical Characteristics T _j = 25°C unless otherwise specified						
Barrandar	0	T . O . III	Value			11.24
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = -250\mu A$	-100			>
Zana Oata Valta va Dusin Ourse i	I _{DSS}	$V_{DS} = -100V, V_{GS} = 0V, T_{J} = 25^{\circ}C$			10	uA
Zero Gate Voltage Drain Current		$V_{DS} = -100V, V_{GS} = 0V, T_{J} = 55^{\circ}C$			100	uA
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 20V$			±100	nA
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-1.2	-1.5	-2.5	V
Drain-Source On-Resistance (note2)	R _{DS(on)}	$V_{GS} = -10V, I_D = -1A$		0.52	0.65	Ω
		$V_{GS} = -4.5V, I_{D} = -0.5A$		0.56	0.7	Ω
Dynamic						
Input Capacitance	C _{iss}	$V_{GS} = 0V$,		553		pF
Output Capacitance	C _{oss}	$V_{DS} = -15V$,		29		
Reverse Transfer Capacitance	C_{rss}	f = 1.0MHz		20		
Total Gate Charge (4.5V)	Q_g			4.5		nC
Gate-Source Charge	Q_{gs}	$V_{DS} = -15V, I_{D} = -1A, V_{GS} = -4.5V$		1.14		
Gate-Drain Charge	Q_{gd}	- 65		1.5		
Turn-on Delay Time	t _{d(on)}			13.6		ns
Turn-on Rise Time	t _r	$V_{DS} = -50V, I_{D} = 1A$		6.8		
Turn-off Delay Time	t _{d(off)}	$V_{GS} = -10V, R_G = 3.3\Omega$		34		
Turn-off Fall Time	t _f			3		
Body Diode Characteristics						
Continuous Body Diode Current	Is	T = 25 0C			-5.3	Α
Pulsed Diode Forward Current	I _{SM}	T _C = 25 °C			-8.5	A
Body Diode Voltage	V_{SD}	$I_{SD} = -1A$, $V_{GS} = 0V$			-1.2	V

Notes

- 1. The data tested by surface mounted on a 1 inch2 FR-4 board with 2OZ copper.
- 2. The data tested by pulsed , pulse width $\leq\!300\text{us}$, duty cycle $\!\leq\!2\%$
- 3. The EAS data shows Max. rating . The test condition is VDD =25V,VGS =10V,L=0.1mH
- 4. The power dissipation is limited by 175°C junction temperature
- 5. The data is theoretically the same as ID and IDM , in real applications , should be limited by total power dissipation.



Typical Characteristics $T_J = 25$ °C, unless otherwise noted

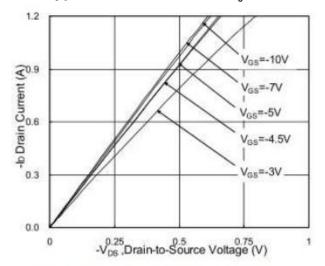


Fig.1 Typical Output Characteristics

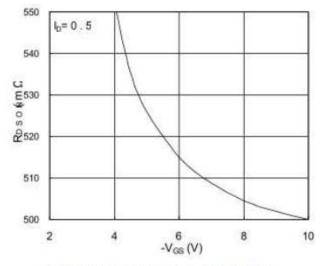


Fig.2 On-Resistance vs. G-S Voltage

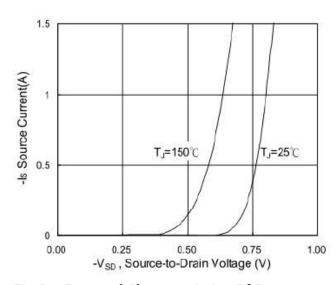
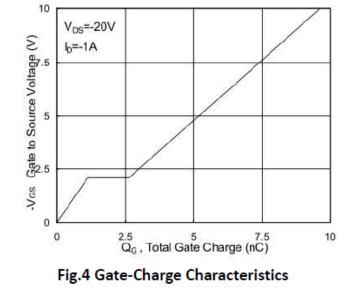


Fig.3 Forward Characteristics Of Reverse



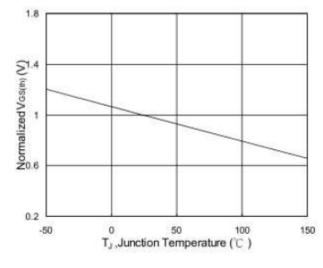


Fig.5 Normalized V GS(th) vs. T J

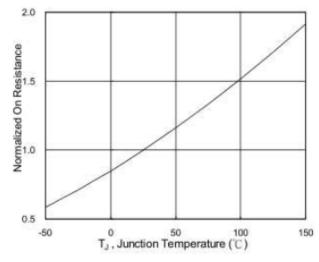
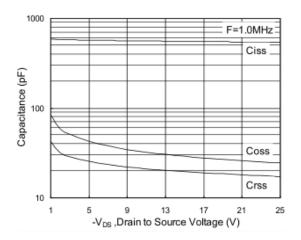


Fig.6 Normalized R DSON vs. T J



Typical Characteristics $T_J = 25^{\circ}\text{C}$, unless otherwise noted



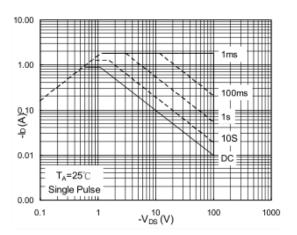


Fig.7 Capacitance

Fig.8 Safe Operating Area

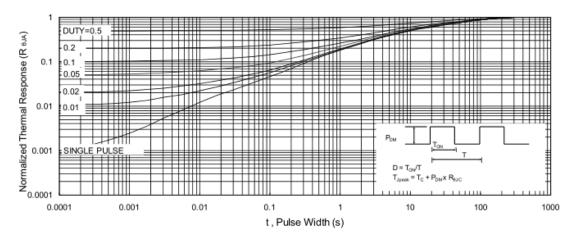


Fig.9 Normalized Maximum Transient Thermal Impedance



Figure A: Gate Charge Test Circuit and Waveform

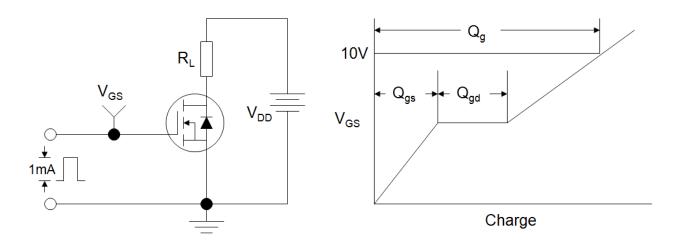


Figure B: Resistive Switching Test Circuit and Waveform

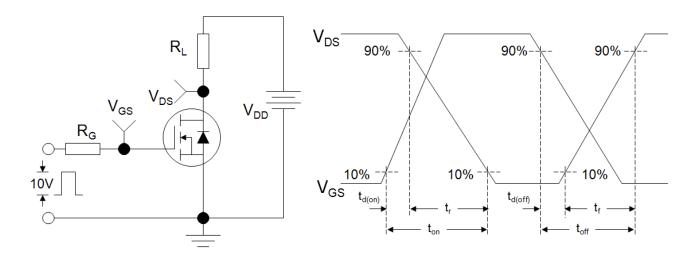
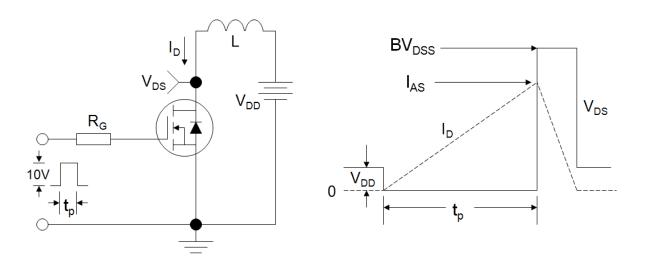
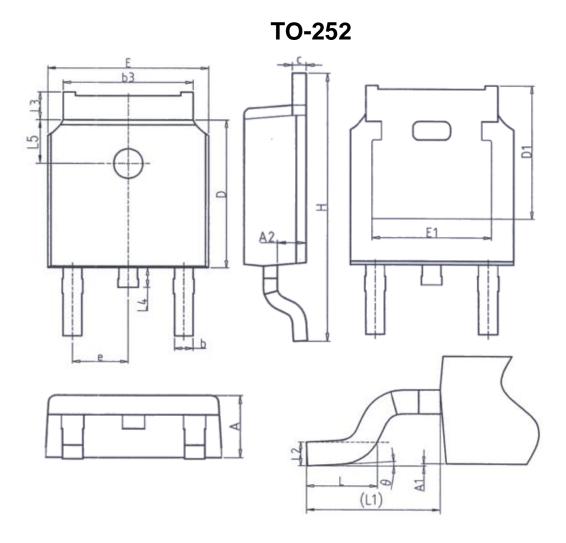


Figure C: Unclamped Inductive Switching Test Circuit and Waveform







Unit: mm				
Symbol	Min.	Max.		
Α	2. 20	2. 40		
A1	0.00	0. 20		
A2	0. 97	1. 17		
b	0. 68	0. 90		
b3	5. 20	5. 50		
С	0. 43	0. 63		
D	5. 98	6. 22		
D1	5. 30REF			
E	6. 40	6. 80		
E1	4. 63	_		

Unit: mm				
Symbol	Min.	Max.		
е	2. 286BSC			
Н	9. 40	10.50		
L	1. 38	1. 75		
L1	2. 90REF			
L2	0. 51BSC			
L3	0.88	1. 28		
L4	_	1.00		
L5	1. 65	1. 95		
θ	0°	8°		



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